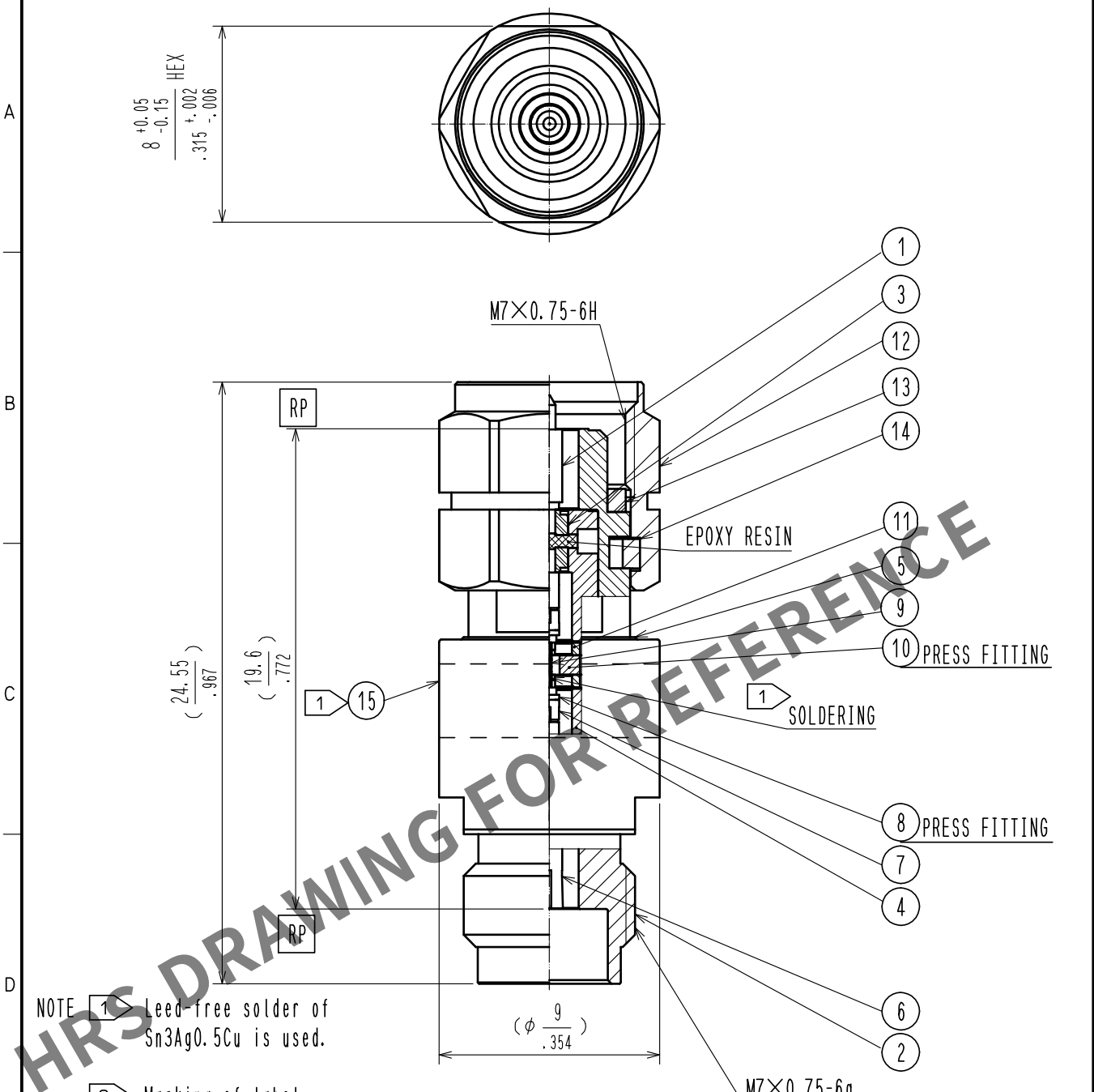




NOTE 1 Lead-free solder of Sn3Ag0.5Cu is used.

2 Marking of label.

1. Part No. H2.4-AT(9)-PJ

2. Production No.

3. Manufacturer abbreviation.

RoHS COMPLIANT

8	BRASS	GOLD PLATING			
7	BERYLLIUM COPPER	GOLD PLATING	15		LABEL
6	STAINLESS STEEL	PASSIVATE	14	BERYLLIUM COPPER	NICKEL PLATING
5	STAINLESS STEEL	PASSIVATE	13	SILICON RUBBER	
4	STAINLESS STEEL	GOLD PLATING	12	STAINLESS STEEL	PASSIVATE
3	PTFE		11	ALUMINIUM	
2	BERYLLIUM COPPER	GOLD PLATING	10	BRASS	GOLD PLATING
1	BRASS	GOLD PLATING	9	ALUMINA	
NO.	MATERIAL	FINISH . REMARKS	NO.	MATERIAL	FINISH . REMARKS

UNITS mm		SCALE 4 : 1		COUNT	DESCRIPTION OF REVISIONS	DESIGNED	CHECKED	DATE
 HIROSE ELECTRIC CO., LTD.	APPROVED : TS. NOBE		18. 07. 10	DRAWING NO.	EDC-384095-00-00			
	CHECKED : MH. OGUSU		18. 07. 10	PART NO.	H2. 4-AT(9)-PJ			
	DESIGNED : HA. NISHIMURA		18. 07. 10	CODE NO.	CL354-0315-0-00			
	DRAWN : HA. NISHIMURA		18. 07. 10	 				